RENESAS

HD74BC244A

Octal Buffers/Line Drivers With 3 State Outputs

REJ03D0281–0300Z (Previous ADE-205-007A (Z)) Rev.3.00 Jul.16.2004

Description

The HD74BC244A provides high drivability and operation equal to or better than high speed bipolar standard logic IC by using Bi-CMOS process. The device features low power dissipation that is about 1/5 of high speed bipolar logic IC, when the frequency is 10 MHz. The device has eight inverter drivers with three state outputs in a 20 pin package. This device is a non inverting buffer and has two active low enables ($1\overline{G}$ and $2\overline{G}$). Each enable independently controls 4 buffers.

Features

- Input/Output are at high impedance state when power supply is off.
- Built in input pull up circuit can make input pins be open, when not used.
- TTL level input
- Wide operating temperature range Ta = -40 to $+ 85^{\circ}C$
- Ordering Information

Part Name	Package Type	Package Code	Package Abbreviation	Taping Abbreviation (Quantity)
HD74BC244AP	DILP-20 pin	DP-20N, -20NEV	Р	—
HD74BC244AFPEL	SOP-20 pin (JEITA)	FP-20DAV	FP	EL (2,000 pcs/reel)
HD74BC244ATELL	TSSOP-20 pin	TTP-20DAV	Т	ELL (2,000 pcs/reel)

Note: Please consults the sales office for the above package availability.

Function Table

In	puts	
G	Α	Output Y
Н	Х	Z
L	Н	Н
L	L	L

H : High level

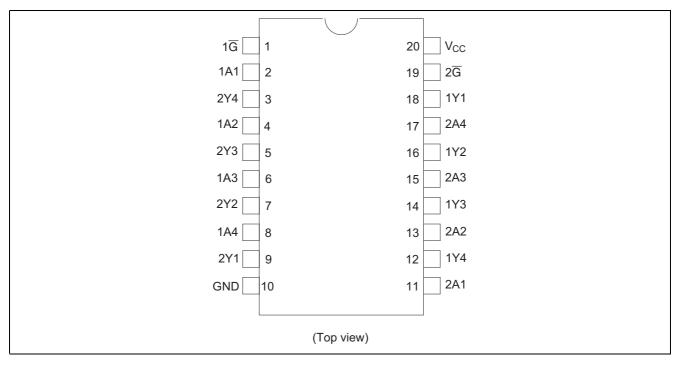
L : Low level

X : Immaterial

Z : High impedance



Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Rating	Unit
Supply voltage	V _{cc}	-0.5 to +7.0	V
Input diode current	I _{IK}	±30	mA
Input voltage	V _{IN}	–0.5 to +7.5	V
Output voltage	V _{OUT}	–0.5 to +7.5	V
Off state output voltage	V _{OUT(off)}	–0.5 to +5.5	V
Storage temperature	Tstg	-65 to +150	°C

Note: 1. The absolute maximum ratings are values which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

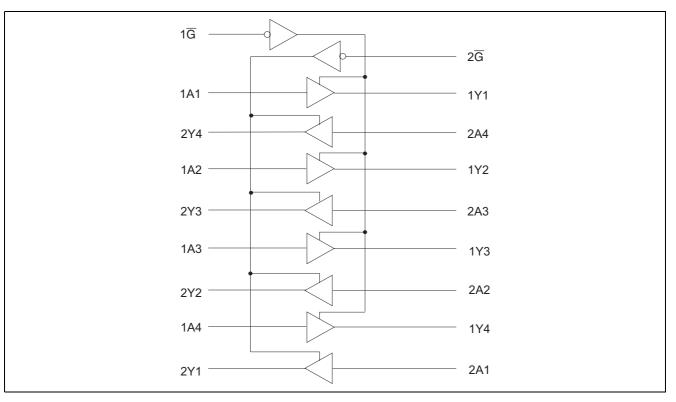
Recommended Operating Conditions

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V _{cc}	4.5	5.0	5.5	V
Input voltage	V _{IN}	0	—	V _{cc}	V
Output voltage	V _{OUT}	0	—	V _{cc}	V
Operating temperature	Topr	-40	—	85	°C
Input rise/fall time*1	t _r , t _f	0	—	8	ns/V

Note: 1. This item guarantees maximum limit when one input switches. Waveform: Refer to test circuit of switching characteristics.



Logic Diagram





Item	Symbol	V _{cc} (V)	Min	Max	Unit	Test Conditions
Input voltage	V _{IH}		2.0	—	V	
	V _{IL}		—	0.8	V	
Output voltage	V _{OH}	4.5	2.4	—	V	I _{OH} = -3 mA
		4.5	2.0	—	V	I _{он} = –15 mA
	V _{OL}	4.5	—	0.5	V	I _{OL} = 48 mA
		4.5	—	0.55	V	I _{OL} = 64 mA
Input diode voltage	V _{IK}	4.5	—	-1.2	V	I _{IN} = -18 mA
Input current	I _I	5.5	—	-250	μA	$V_{IN} = 0 V$
		5.5	—	1.0	μA	V _{IN} = 5.5 V
		5.5	—	100	μA	V _{IN} = 7.0 V
Short circuit output current*1	I _{os}	5.5	-100	-225	mA	V _{IN} = 0 or 5.5 V
Off state output current	I _{ozh}	5.5	_	50	μA	V ₀ = 2.7 V
	I _{OZL}	5.5	—	-50	μA	V ₀ = 0.5 V
Supply current	I _{CCL}	5.5	—	29.5	mA	V _{IN} = 0 or 5.5 V
						All outputs is "L"
	I _{CCH}	5.5	—	0.5	mA	V _{IN} = 0 or 5.5 V
						All outputs is "H"
	I _{ccz}	5.5	—	2.5	mA	$V_{IN} = 0 \text{ or } 5.5 \text{ V}$
						All outputs is "Z"
	I _{CCT} * ²	5.5	—	1.5	mA	V _{IN} = 3.4 or 0.5 V

Electrical Characteristics (Ta = -40° C to $+85^{\circ}$ C)

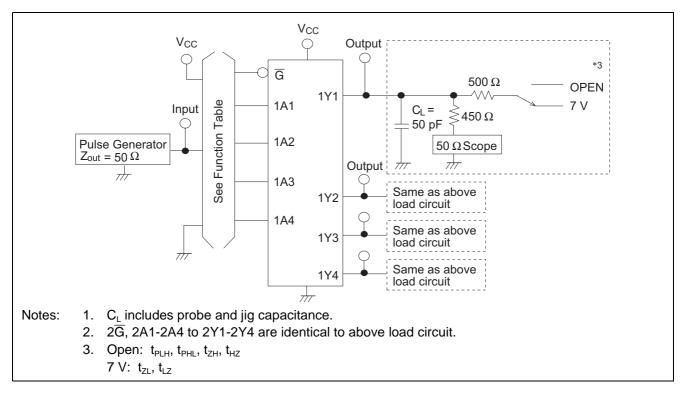
Notes : 1. Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

2. When input by the TTL level, it shows I_{CC} increase at per one input pin.

Switching Test Method ($C_L = 50 \text{ pF}$)

		Ta = 25°C V _{cc} = 5.0 V		Ta = -40 to 85°C V _{cc} = 5.0 V ±10%			
Item	Symbol	Min	Max	Min	Max	Unit	Test Conditions
Propagation delay time	t _{PLH}	3.0	6.0	3.0	7.0	ns	See under figure
	t _{PHL}	3.0	6.0	3.0	7.0		
Output enable time	t _{zH}	3.0	8.0	3.0	10.0	ns	
	t _{zL}	3.0	8.0	3.0	10.0		
Output disable time	t _{HZ}	3.0	7.0	3.0	9.0	ns	
	t _{LZ}	3.0	7.0	3.0	9.0		
Input capacitanse	CIN	3.0(Typ)		—	—		$V_{IN} = V_{CC}$ or GND
Output capacitance	Co	15.0(Typ)		_	—		$V_0 = V_{CC}$ or GND

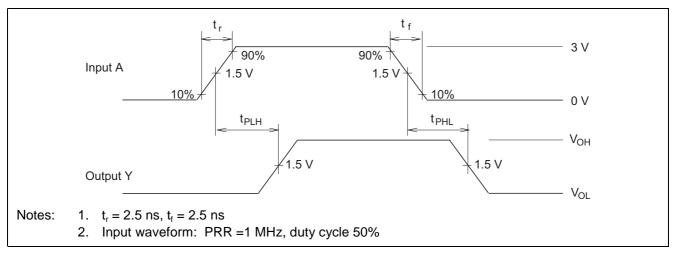
Test Circuit



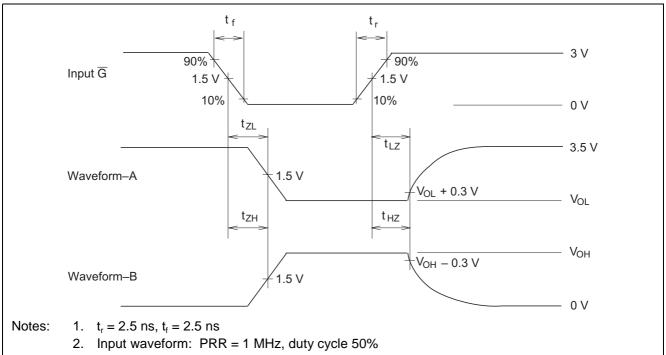


HD74BC244A

Waveforms-1



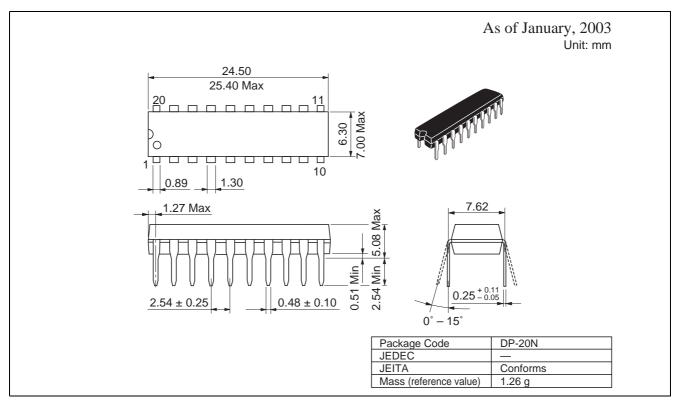
Waveforms-2

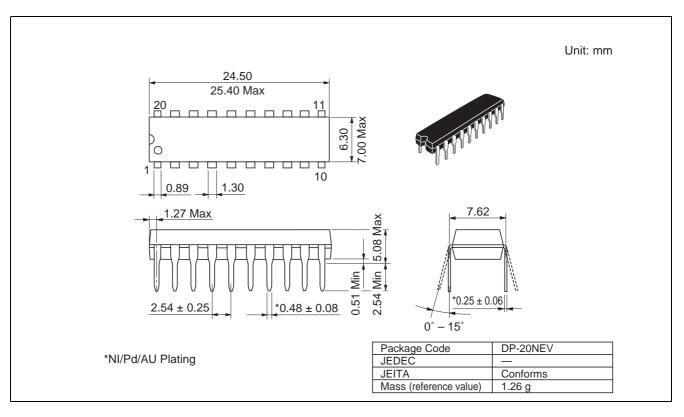


- 3. Waveform-A shows input conditions such that the output is "L" level when enable by the output control.
- 4. Waveform-B shows input conditions such that the output is "H" level when enable by the output control.

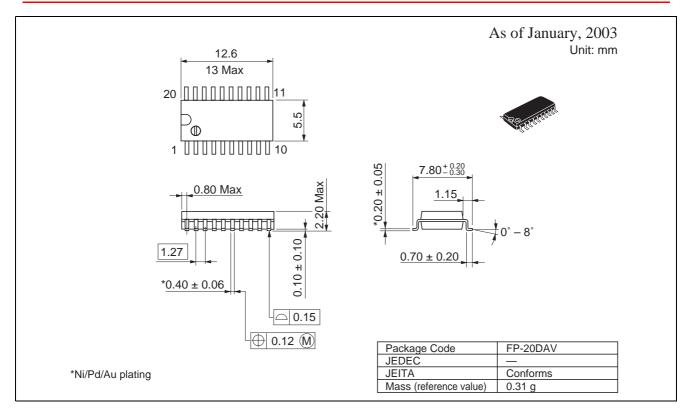


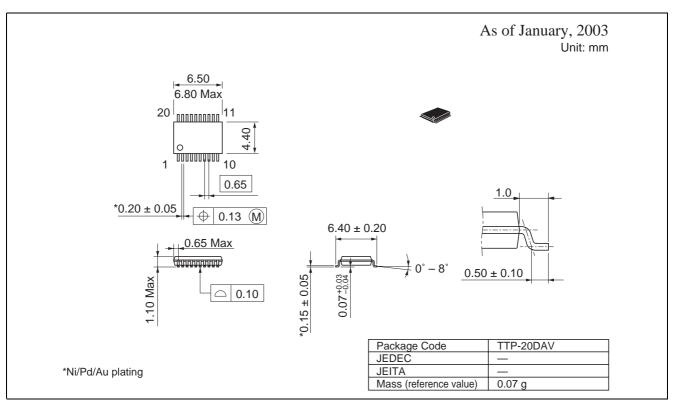
Package Dimensions











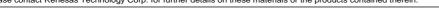


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450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500 Fax: <1> (408) 382-7501

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Renesas Technology Singapore Pte. Ltd. 1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001